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Part Number:	<u>5055670371</u>			205
Status:	Active			
Overview:	ew: Micro-Lock Plus Wire-to-Board Connector System		2	
			A.	
Description:	Plating, Positive Lock		$\leq$	
	Flating, Fusitive Lock	, 5 Circuits, Diack	0.	
Decumenter			200	
Documents:		Application Creation AC EDEECE 004 004 (DDE)		
Drawing (PDF)		Application Specification AS-505565-001-001 (PDF)	1.1	
<u>3D Model (PDF)</u> 3D Model		Packaging Specification 5055679200-200 (PDF) Datasheet (PDF)		
	ation 5055650000-000 (PDF)		Series image - Reference only	
	ation 5055651002-PS-000 (PDI)			ge - Reference only
	alon 303303 1002-1 3-000 (1			
	<b></b>		EU ELV	
Agency Certification		F00470	Not Relevant	
UL		E29179	EU RoHS	China RoHS
General			Compliant	
Product Family		PCB Headers	REACH SVHC	
Series		505567	Not Contained Pe	r -
Application		Signal, Wire-to-Board	D(2021)4569-DC	
Overview		Micro-Lock Plus Wire-to-Board Connector System	July 2021)	(6
Product Name		Micro-Lock Plus	Halogen-Free	
UPC		889056534222	<u>Status</u>	
010			Not Low-Haloger	
Physical				ion, please visit <u>Contact US</u>
Breakaway		No		ion, please visit <u>contact oc</u>
Circuits (Loaded)		3	China ROHS	Green Image
Circuits (maximum)		3	ELV	Not Relevant
Color - Resin		Black	RoHS Phthalates	Not Contained
Durability (mating		30		
First Mate / Last Break		No		
Glow-Wire Capable		No	Search Parts in this Series	
Guide to Mating Part		No	505567 Series	
Keying to Mating Part		None	<u>303307</u> Series	
Lock to Mating Pa	art	Yes		
Material - Metal		Brass	Mates With	
Material - Plating Mating		Tin-Bismuth		Receptacle Housing
Material - Plating Termination		Tin-Bismuth		Lock Plus Cable Assembly
Material - Resin		Polyamide	<u>45111</u>	
Net Weight		140.431/mg		
Number of Rows		1		
Orientation		Right Angle		
PCB Locator		No		
PCB Retention		Yes		
Packaging Type		Embossed Tape on Reel		
Pitch - Mating Interface		1.25mm		
Pitch - Termination Interface		1.25mm		
Plating min - Mating Relarized to Mating Part		1.000µm		
Polarized to Mating Part		Yes		
Polarized to PCB Robotic Placeme		Yes Vaguum Bick Up Argo		
	111	Vacuum Pick-Up Area		
Stackable		No $40^{\circ}$ to $105^{\circ}$ C		
Temperature Range - Operating Termination Interface: Style		-40° to +105°C Surface Mount		
remination inter	iace. Siyle			
Electrical				

1.5A

Current - Maximum per Contact

50V AC (RMS)/DC

**Material Info** 

**Reference - Drawing Numbers** Application Specification Packaging Specification Product Specification Sales Drawing

AS-505565-001-001 5055679200-200 5055650000-000, 5055651002-PS-000 5055670000-SD-000

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